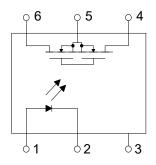


Description

The KAQV414 series is robust, ideal for telecom and ground fault applications. It is a SPST normally close switch (1 Form B) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, is comprised of a photodiode array, switch control circuitry and MOSFET switches.

Schematic



1 FORM B
NORMALLY CLOSE

1 ∘ → 2

Features

- 1. Normally close, single pole single throw
- 2. Control 400V AC or DC voltage
- 3. Switch 130mA loads
- 4. Controls low-level analog signals
- 5. High sensitivity, low ON resistance
- 6. Low-level off-state leakage current
- 7. High isolation voltage 5KV (DIP / SMD)
- 8. Pb free and RoHS compliant
- 9. MSL class 1
- 10. Agency Approvals:
 - UL Approved (No. E108430): UL508
 - c-UL Approved (No. E108430)
 - FIMKO Approved: EN62368-1, EN60601-1
 - VDE Approved (No. 40053989): EN60747-5-5

Application

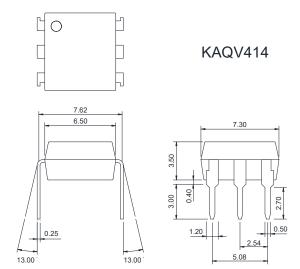
- Telecommunications (PC, electronic notepad)
- Modem
- Telephone equipment
- Security equipment
- Sensors
- Measuring and testing equipment
- Factory automation equipment
- · High speed inspection machines

Unit: mm

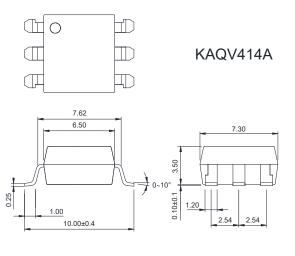
6PIN 400V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Outside Dimension

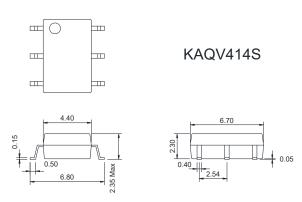
1. Dual-in-line type.



2. Surface mount type.

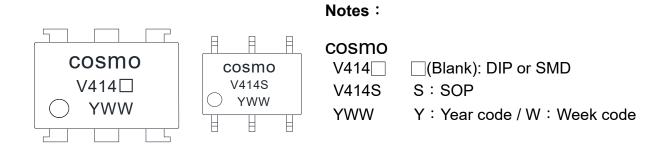


3. Small outline for surface mount type.



TOLERANCE: ±0.2mm

Device Marking



KAQV414 Series

6PIN 400V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Absolute Maximum Ratings

(Ta=25°℃)

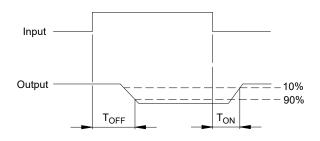
ltem		Symbol	Rating	Unit
	Continuous forward current	I _F	50	mA
Input	Peak forward current	I _{FP}	1	A
	Reverse voltage	V_R	5	V
	Power dissipation	P _{in}	100	mW
	Derate linearly from 25℃	-	1.3	mW/°C
	Breakdown voltage	V _B	400	V
Output	Continuous load current	IL	130	mA
	Power dissipation	P _{out}	500	mW
lealeties	Isolation voltage		KAQV414S	KAQV414
isolation			1500Vrms	5000Vrms
Isolation resistance (Vio=500V)		R _{iso}	$\ge 10^{10}$	Ω
Total power dissipation		P _t	550	mW
Derate linearly from 25℃		-	2.5	mW/°C
Operating temperature		T _{opr}	-40 to +85	$^{\circ}\!\mathbb{C}$
Storage temperature		T _{stg}	-40 to +125	$^{\circ}\mathbb{C}$
Junction temperature		T _j	100	$^{\circ}\!\mathbb{C}$
Soldering temperature 10 seconds		T _{sot}	260	$^{\circ}\!\mathbb{C}$

• Electro-optical Characteristics

(Ta=25°ℂ)

Parameter			Symbol	Conditions	Min.	Тур.	Max.	Unit	
	Forward voltage		V _F	I _F =10mA	-	1.2	1.5	V	
Input	Operation input current		I _{FOFF}	V_L =20V, I_L \leq 5 μ A	-	1	3.0	mA	
	Recovery input current		I _{FON}	V _L =20V, I _L =100mA	0.2	-	-	mA	
Output	Breakdown voltage		V_B	I _B =50μA, I _F =10mA	400	-	-	V	
Output	Off-state leakage current		I _{LEAK}	V _L =100V, I _F =5mA	-	1.0	2.0	μA	
I/O capacitance			C _{iso}	V _B =0V, f=1MHz	-	6	-	pF	
ON resistance			Α		I _F =0mA, I _L =100mA	-	25	50	
		Connection	В	R _{ON}		-	13	25	Ω
			С			-	7	12.	
Reverse (ON) time			T _{ON}	I _F =10mA, V _L =20V	-	0.6	1.5	ms	
Operate (OFF) time			T _{OFF}	I _L =100mA, t=10ms	-	0.3	1.0	ms	

Turn-on / Turn-off Time





KAQV414 Series

6PIN 400V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

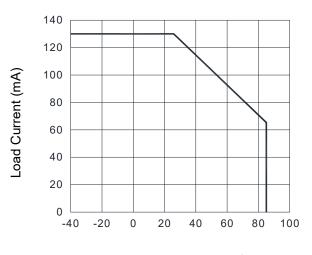
Schematic and Wiring Diagrams

Schematic Output Configuration		Load	Connection	Wiring Diagrams
	1b	AC DC	А	V _N
2 5 5 6		DC	В	V _n — V _n — V _t (DC) s
		DC	С	Vs. Table 2 3 Load V. (DC)

KAQV414 Series

6PIN 400V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Fig.1 Load Current vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.3 Operate (OFF) Time vs. Ambient Temperature

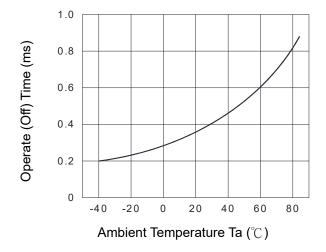
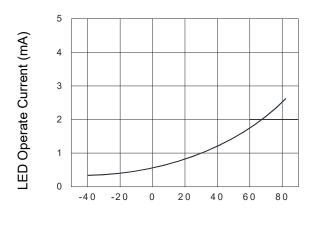
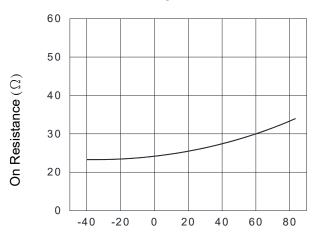


Fig.5 LED Operate Current vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.2 On Resistance vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.4 Reverse (ON) Time vs. Ambient Temperature

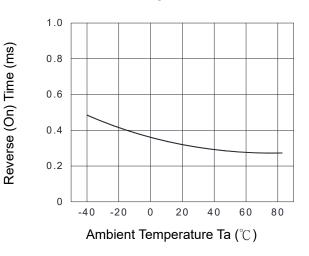
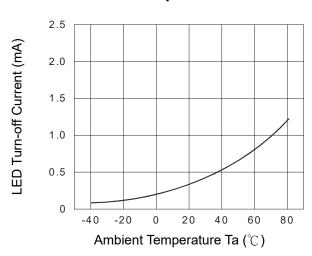


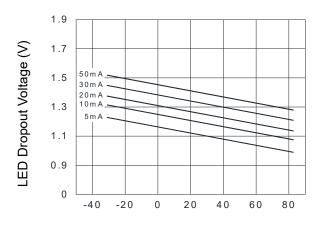
Fig.6 LED Turn-off Current vs. Ambient Temperature



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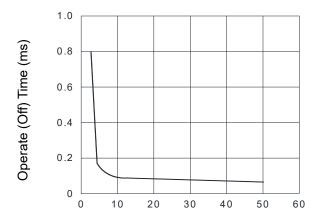
http://www.cosmo-ic.com

Fig.7 LED Dropout Voltage vs. Ambient Temperature



Ambient Temperature Ta (℃)

Fig.9 Operate (OFF) Time vs. LED Forward Current



LED Forward Current (mA)

Fig.11 Reverse (ON) Time vs. LED Forward Current

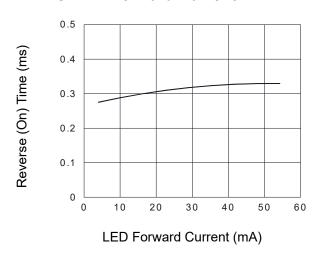
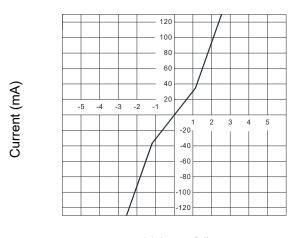
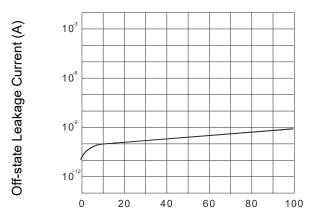


Fig.8 Voltage vs. Current Characteristics of Output at MOSFET Portion



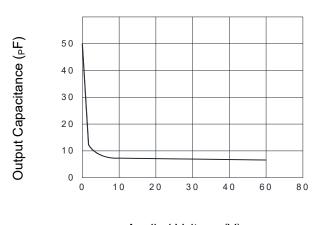
Voltage (V)

Fig.10 Off-state Leakage Current vs. Load Voltage



Load Voltage (V)

Fig.12 Output Capacitance vs. Applied Voltage

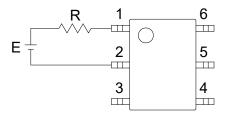


Applied Voltage (V)



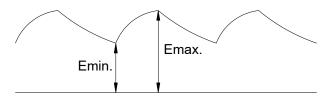
Using Methods

Examples of resistance value to control LED forward current (I_F=5mA)

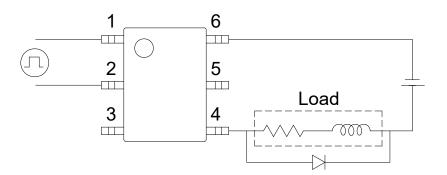


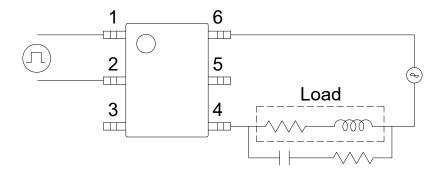
Е	R		
3.3V Approx. 330 Ω			
5V	Approx. 640 Ω		
12V	Approx. 1.9K Ω		
15V	Approx. 2.5K Ω		
24V	Approx. 4.1K Ω		

- 1. LED forward current must be more than 5mA, at E min.
- 2. LED forward current must be less than 50mA, at E max.



Regulate the spike voltage generated on the inductive load as follows:





R-C Snubber



KAQV414 Series 6PIN 400V N.C. TYPE SOLID STATE RELAY-MOSFET OUTPUT

Recommended Soldering Conditions

(a) Infrared reflow soldering:

■ Peak reflow soldering : 260°C or below (package surface temperature)

■ Time of peak reflow temperature: 10 sec

■ Time of temperature higher than 230°C : 30-60 sec
 ■ Time to preheat temperature from 60-120 sec

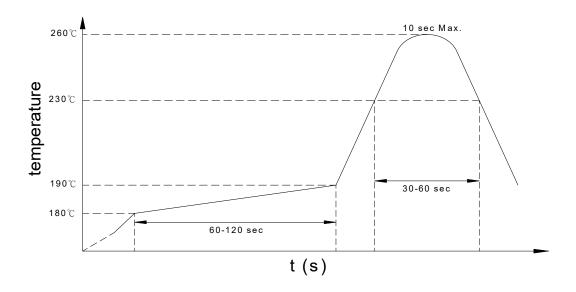
180~190°C ∶ Two

■ Number of reflows: Rosin flux containing small amount of chlorine (The

■ Flux : flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering:

■ Temperature : 260°C or below (molten solder temperature)

■ Time: 10 seconds or less

■ Preheating conditions: 120°C or below (package surface temperature)

■ Number of times : One

■ Flux : Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions:

■ Fluxes: Avoid removing the residual flux with freon-based and

chlorine-based cleaning solvent.

Avoid shorting between portion of frame and leads.



Numbering System

KAQV414 <u>X</u> (Y)

Note:

KAQV414 = Part No.

X = Lead form option (blank · S or A)

Y = Tape and reel option (TL · TR)

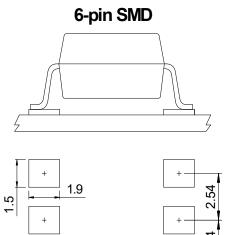
Option	Description	Packing quantity		
A (TL)	surface mount type package + TL tape & reel option	1000 units per reel		
A (TR)	surface mount type package + TR tape & reel option	1000 units per reel		
S (TL)	small outline for surface mount type package + TL tape & reel option	2000 units per reel		
S (TR)	small outline for surface mount type package + TR tape & reel option	2000 units per reel		

Recommended Pad Layout for Surface Mount Lead Form

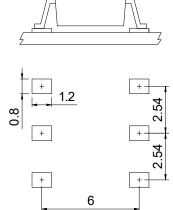
1. Surface mount type.

2. Small outline for surface mount type.

6-pin SOP



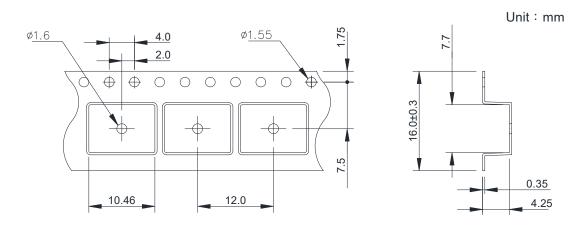
8.3



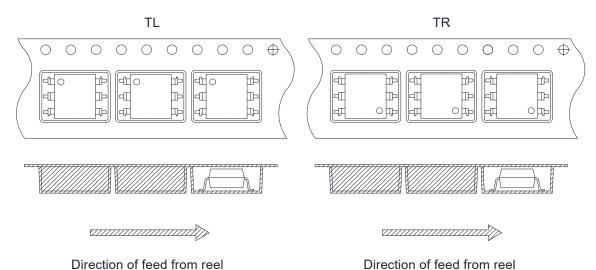
 $\mathsf{Unit}:\mathsf{mm}$



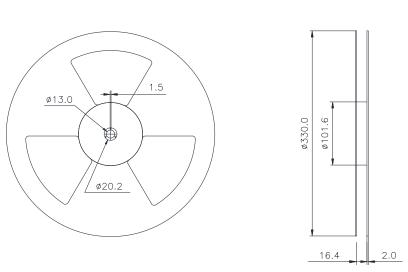
6-pin SMD Carrier Tape & Reel



TOLERANCE: ±0.2mm

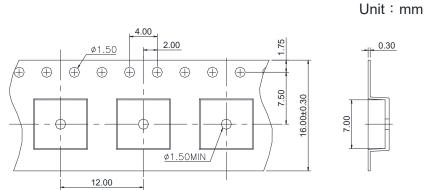


Direction of feed from reel

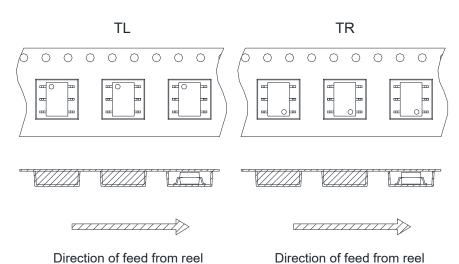




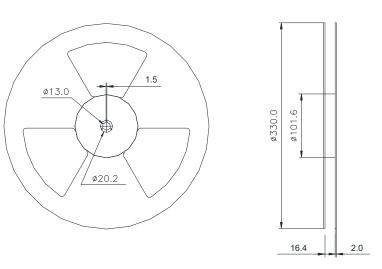
6-pin SOP Carrier Tape & Reel



TOLERANCE: ±0.2mm



Direction of feed from reel





Application Notice

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